

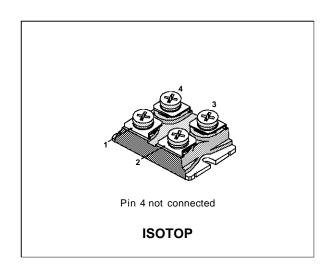
BUV98AV

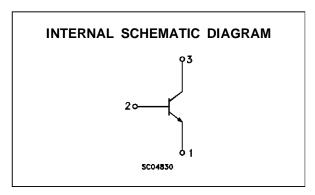
NPN TRANSISTOR POWER MODULE

- HIGH CURRENT POWER BIPOLAR MODULE
- VERY LOW R_{th} JUNCTION CASE
- SPECIFIED ACCIDENTAL OVERLOAD AREAS
- ISOLATED CASE (2500V RMS)
- EASY TO MOUNT
- LOW INTERNAL PARASITIC INDUCTANCE

INDUSTRIAL APPLICATIONS:

- MOTOR CONTROL
- SMPS & UPS
- WELDING EQUIPMENT





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CEV}	Collector-Emitter Voltage (V _{BE} = -5 V)	1000	V	
V _{CEO(sus)}	Collector-Emitter Voltage (I _B = 0)	450	V	
V _{EBO}	Emitter-Base Voltage (I _C = 0)	7	V	
Ic	Collector Current	30	Α	
Ісм	Collector Peak Current (tp = 10 ms)	60	Α	
lΒ	Base Current	8	Α	
I _{BM}	Base Peak Current (t _p = 10 ms)	30	Α	
P _{tot}	Total Dissipation at T _c = 25 °C	150	W	
T _{stg}	Storage Temperature	-55 to 150	°C	
Tj	Max. Operating Junction Temperature	150	°C	
V _{ISO}	Insulation Withstand Voltage (AC-RMS)	2500	V	

January 1995 1/7

THERMAL DATA

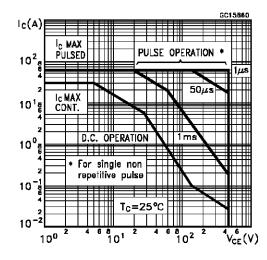
R _{thj-case}	Thermal Resistance Junction-case	Max	0.83	°C/W
R _{thc-h}	Thermal Resistance Case-heatsink With Co	onductive		
	Grease Applied	Max	0.05	°C/W

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

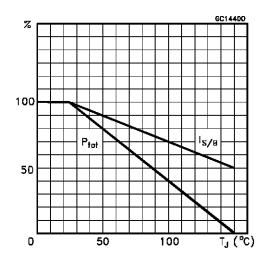
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ICER	Collector Cut-off Current ($R_{BE} = 5 \Omega$)	V _{CE} = V _{CEV} V _{CE} = V _{CEV} T _j = 100 °C			1 8	mA mA
ICEV	Collector Cut-off Current (V _{BE} = -5V)	V _{CE} = V _{CEV} V _{CE} = V _{CEV} T _j = 100 °C			0.4 4	mA mA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 5 V			2	mA
VCEO(SUS)*	Collector-Emitter Sustaining Voltage	I _C = 0.2 A L = 25 mH V _{clamp} = 450 V	450			V
h _{FE} *	DC Current Gain	I _C = 24 A V _{CE} = 5 V		9		
V _{CE(sat)*}	Collector-Emitter Saturation Voltage	I _C = 16 A I _B = 3.2 A I _C = 24 A I _B = 5 A			1.5 5	\ \ \
V _{BE(sat)*}	Base-Emitter Saturation Voltage	I _C = 16 A I _B = 3.2 A			1.6	V
di _C /dt	Rate of Rise of On-state Collector	$V_{CC} = 300 \text{ V}$ $R_C = 0$ $t_p = 3 \mu s$ $I_{B1} = 6 \text{ A}$ $T_j = 100 ^{\circ}\text{C}$	100			A/μs
V _{CE} (3 μs)	Collector-Emitter Dynamic Voltage	$V_{CC} = 300 \text{ V}$ $R_{C} = 15 \Omega$ $I_{B1} = 6 \text{ A}$ $T_{j} = 100 ^{\circ}\text{C}$			8	V
V _{CE} (5 μs)	Collector-Emitter Dynamic Voltage	$V_{CC} = 300 \text{ V}$ $R_{C} = 15 \Omega$ $I_{B1} = 6 \text{ A}$ $T_{j} = 100 ^{\circ}\text{C}$			4	V
t _s t _f	Storage Time Fall Time				5 0.4	μs μs
V _{CEW}	Maximum Collector Emitter Voltage Without Snubber	$\begin{split} I_{CWoff} &= 30 \text{ A} & I_{B1} &= 6 \text{ A} \\ V_{BB} &= -5 \text{ V} & V_{CC} &= 50 \text{ V} \\ L &= 750 \mu\text{H} & L_{B} &= 15 \mu\text{H} \\ T_{j} &= 125 ^{\circ}\text{C} \end{split}$	350			V

^{*} Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

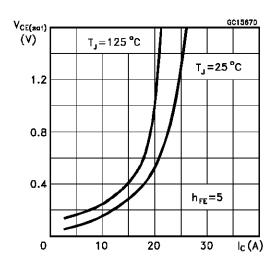
Safe Operating Areas



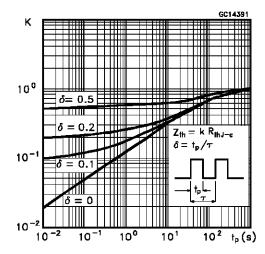
Derating Curve



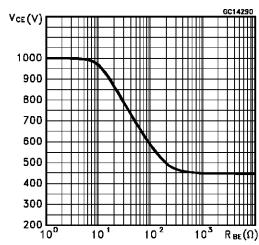
Collector-Emitter Saturation Voltage



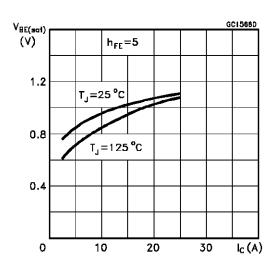
Thermal Impedance



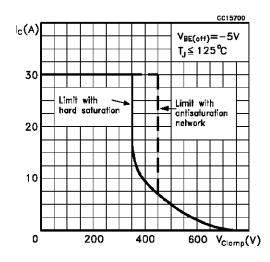
Collector-Emitter Voltage Versus Base-Emitter Resistance



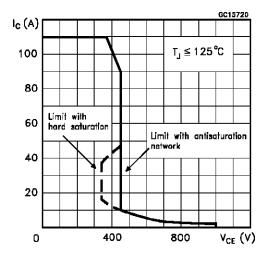
Base-Emitter Saturation Voltage



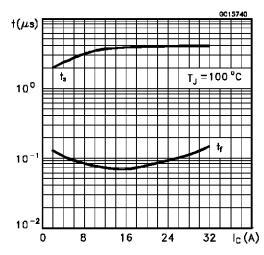
Reverse Biased SOA



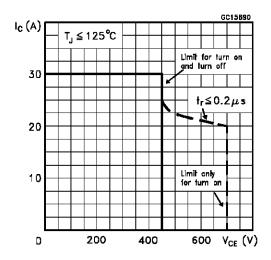
Reverse Biased AOA



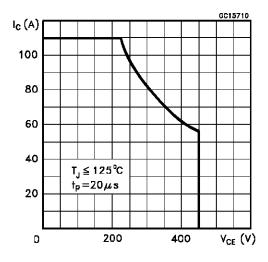
Switching Times Inductive Load



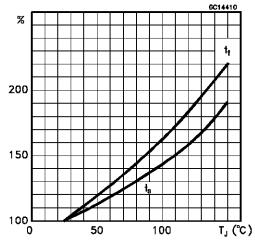
Forward Biased SOA



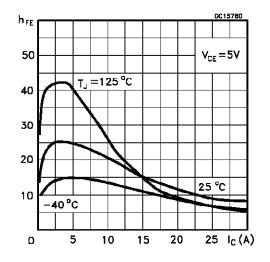
Forward Biased AOA



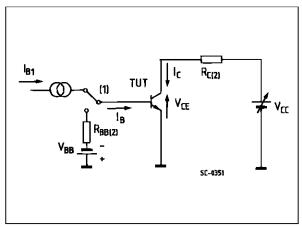
Switching Times Inductive Load Versus Temperature



DC Current Gain

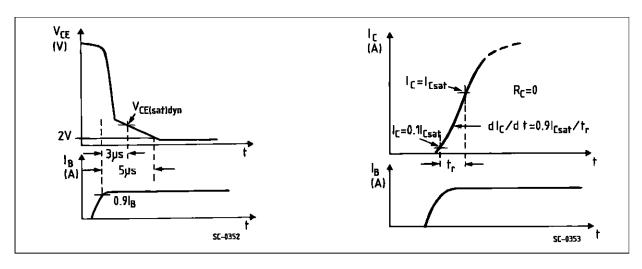


Turn-on Switching Test Circuit

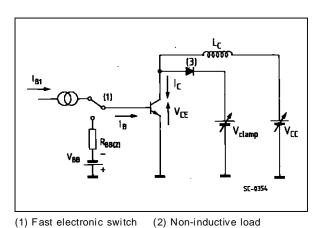


(1) Fast electronic switch (2) Non-inductive load

Turn-on Switching Waveforms

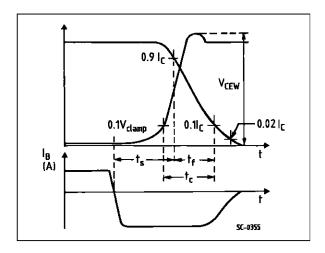


Turn-off Switching Test Circuit



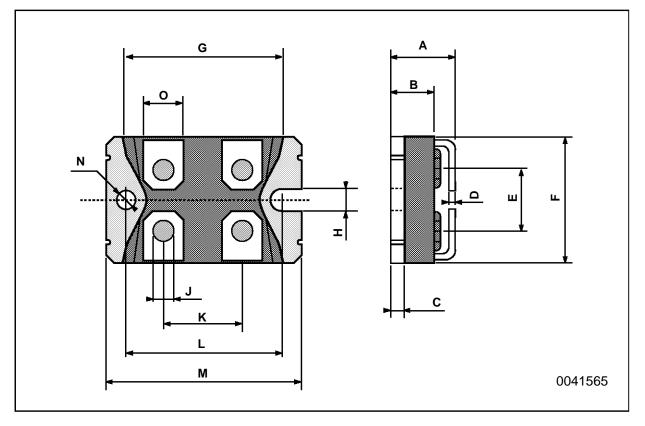
(1) Fast electronic switch(3) Fast recovery rectifier

Turn-off Switching Waveforms



ISOTOP MECHANICAL DATA

DIM.		mm			inch	
DIW.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	11.8		12.2	0.466		0.480
В	8.9		9.1	0.350		0.358
С	1.95		2.05	0.076		0.080
D	0.75		0.85	0.029		0.033
E	12.6		12.8	0.496		0.503
F	25.15		25.5	0.990		1.003
G	31.5		31.7	1.240		1.248
Н	4			0.157		
J	4.1		4.3	0.161		0.169
K	14.9		15.1	0.586		0.594
L	30.1		30.3	1.185		1.193
М	37.8		38.2	1.488		1.503
N	4			0.157		
0	7.8	_	8.2	0.307		0.322
Р	5.5			0.216		



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